



Supplemental Application Data Sheet

Application Information

<u>Application Serial No.::</u>	<u>10/512,405</u>
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	HIGH-RESISTANCE SILICON WAFER AND ITS MANUFACTURING METHOD
Attorney Docket Number::	474082002800
Request for Early Publication?::	No
Request for Non-Publication?::	No
Total Drawing Sheets::	6
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

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Correspondence Information

Correspondence Customer Number:: 25227

Representative Information

Representative Customer Number:: 25227

Continuity Information

This application is a:: 35 USC 371
Application No.:: PCT/JP03/04866
Filing Date:: April 16, 2003

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-127509	April 26, 2002	Yes
Japan	2002-360731	December 12, 2002	Yes

Assignee Information

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